

## 100V N-Channel Enhancement Mode MOSFET

### 1. Product Information

#### 1.1 Features

- ◇ Advanced SGT cell design
- ◇ Low Gate Charge
- ◇ Low On-Resistance
- ◇ RoHS and Halogen-Free Compliant
- ◇ 100%  $\Delta V_{DS}$  & UIS & Rg Tested

#### 1.2 Applications

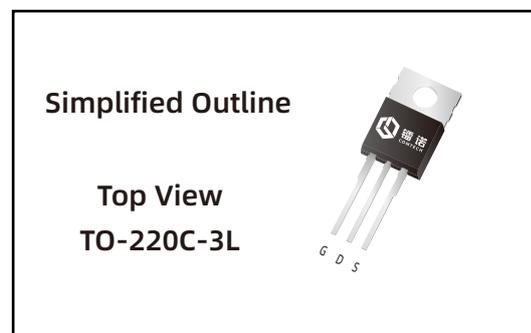
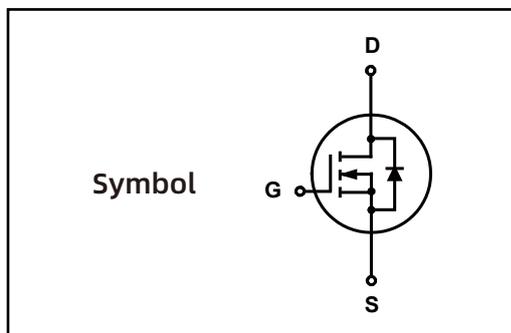
- ◇ DC-DC Converter
- ◇ Drones
- ◇ Motor drivers
- ◇ Light electric vehicles

#### 1.3 Quick reference

- ◇  $BV \cong 100\text{ V}$
- ◇  $P_{\text{tot}} \cong 481\text{ W}$
- ◇  $I_D \cong 342\text{ A}$
- ◇  $R_{DS(ON)} \cong 2.4\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- ◇  $R_{DS(ON)} \cong 3.0\text{ m}\Omega @ V_{GS} = 6\text{ V}$



### 2. Pin Description



### 3.Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit	Note
$V_{DS}$	Drain-Source Voltage	$T_c = 25\text{ }^\circ\text{C}$	-	100	V	-
$V_{GS}$	Gate-Source Voltage	$T_c = 25\text{ }^\circ\text{C}$	-	$\pm 20$	V	-
$I_D^*$	Drain Current ( DC )	$T_c = 25\text{ }^\circ\text{C}, V_{GS} = 10\text{ V}$	-	342	A	Fig.2
		$T_c = 100\text{ }^\circ\text{C}, V_{GS} = 10\text{ V}$	-	217	A	
$I_{DM}^{**},^{***}$	Drain Current ( Pulsed )	$T_c = 25\text{ }^\circ\text{C}, V_{GS} = 10\text{ V}$	-	520	A	-
$P_{tot}$	Drain power dissipation	$T_c = 25\text{ }^\circ\text{C}$	-	481	W	Fig.1
		$T_c = 100\text{ }^\circ\text{C}$	-	192	W	
$T_{stg}$	Storage Temperature		-55	150	$^\circ\text{C}$	-
$T_j$	Junction Temperature		-	150	$^\circ\text{C}$	-
$I_S$	Continuous-Source Current	$T_c = 25\text{ }^\circ\text{C}$	-	342	A	-
$E_{AS}^*$	Single Pulsed Avalanche Energy	$V_{DD} = 100\text{ V}, L = 1\text{ mH}$	-	968	mJ	Fig.19

### 4.Thermal Characteristics

$R_{\theta JA}^*$	Thermal Resistance- Junction to Ambient	-	25.3	$^\circ\text{C/W}$	Fig.16
$R_{\theta JC}^*$	Thermal Resistance- Junction to Case	-	0.26		

Notes :

- \* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10\text{ sec}$
- \*\* Pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$
- \*\*\* limited by bonding wire

### 5.Marking Information

Product Name	Package	Reel size	Tape width	Quantity	Note
LN019N100C	TO-220C-3L	-	-	50	

Note: COMTECH defines “ Green ” as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

## 6. Electrical Characteristics ( $T_A=25^\circ$ Unless Otherwise Noted )

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	Note
<b>Static Characteristics</b>							
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_{DS} = 250\ \mu\text{A}$	100	-	-	V	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{DS} = 250\ \mu\text{A}$	2	-	4	V	
$I_{DSS}$	Drain Leakage Current	$V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V}$	-	-	1	$\mu\text{A}$	
$I_{GSS}$	Gate Leakage Current	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$	-	-	$\pm 100$	nA	
$R_{DS(on)}^a$	On-State Resistance	$V_{GS} = 10\text{ V}, I_{DS} = 50\text{ A}$	-	2.3	2.4	m $\Omega$	Fig.8
		$V_{GS} = 6\text{ V}, I_{DS} = 30\text{ A}$	-	2.9	3.0		
<b>Diode Characteristics</b>							
$V_{SD}^a$	Diode Forward Voltage	$I_{SD} = 50\text{ A}, V_{GS} = 0\text{ V}$	-	-	1.3	V	Fig.7
$t_{rr}$	Reverse Recovery Time	$I_{DS} = 50\text{ A}, V_{GS} = 0\text{ V}$ $dI_{SD}/dt = 100\text{ A}/\mu\text{s}$	-	57	-	nS	Fig.20
$Q_{rr}$	Reverse Recovery Charge		-	277	-	nC	
<b>Dynamic Characteristics<sup>b</sup></b>							
$C_{ISS}$	Input Capacitance	$V_{GS} = 0\text{ V}, V_{DS} = 50\text{ V}$ Frequency = 1 MHz	-	11268	-	pF	Fig.10
$C_{OSS}$	Output Capacitance		-	3165	-		
$C_{rSS}$	Reverse Transfer Capacitance		-	76	-		
$R_G$	Gate Resistance	F= 1 MHz	-	1.6	-	$\Omega$	
$t_d(on)$	Turn-on Delay Time	$V_{DS} = 50\text{ V}, V_{GS} = 10\text{ V},$ $R_G=2.8\ \Omega, R_L = 8\ \mu\text{H},$ $I_{DS} = 50\text{ A}$	-	50	-	nS	Fig.18
$t_r$	Turn-on Rise Time		-	112	-		
$t_d(off)$	Turn-off Delay Time		-	94	-		
$t_f$	Turn-off Fall Time		-	52	-		
$dv/dt$	Peak Diode Recovery		-	0.359	-		
$di/dt$	Peak Diode Recovery	-	802	-	A/us		
<b>Gate Charge Characteristics<sup>b</sup></b>							
$Q_g$	Total Gate Charge	$V_{DS} = 50\text{ V}, V_{GS} = 10\text{ V},$ $I_{DS} = 50\text{ A}$	-	175	-	nC	Fig.9
$Q_{gs}$	Gate-Source Charge		-	45	-		
$Q_{gd}$	Gate-Drain Charge		-	52	-		
$V_{plateau}$	Gate plateau voltage		-	4.5	-		

Notes :

a : Pulse test ; pulse width  $\leq 300\ \mu\text{s}$ , duty cycle  $\leq 2\%$ 

b : Guaranteed by design, not subject to production testing

## 7. Typical Characteristics

Fig.1 Power Capability

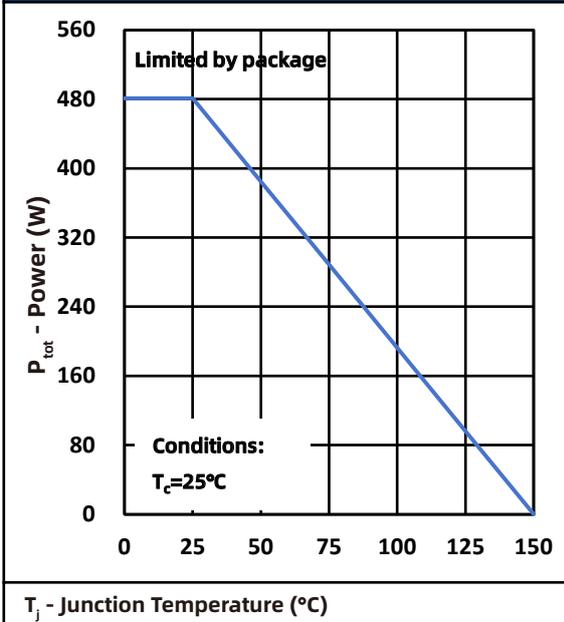


Fig.2 Current Capability

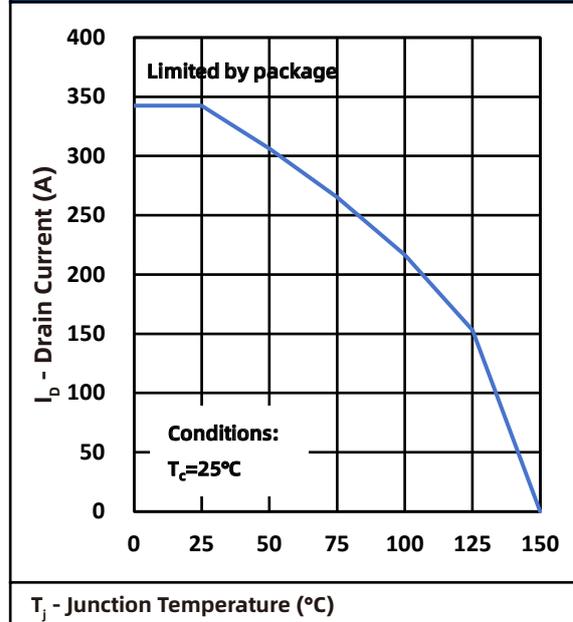


Fig.3 Output Characteristics@ $T_j -55^\circ\text{C}$

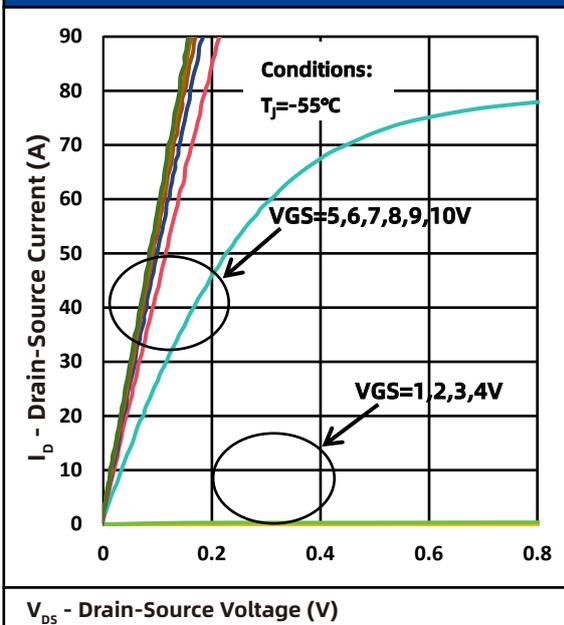
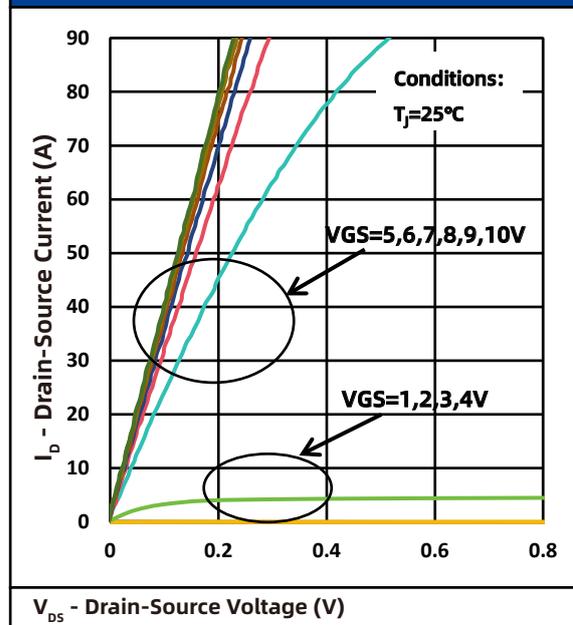
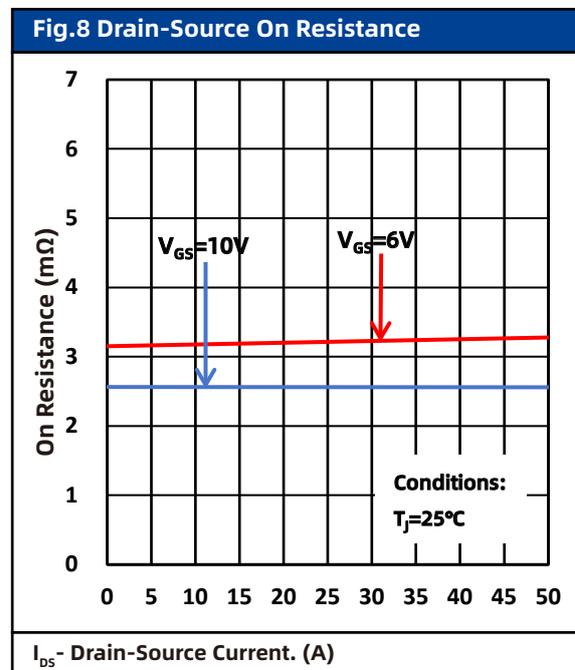
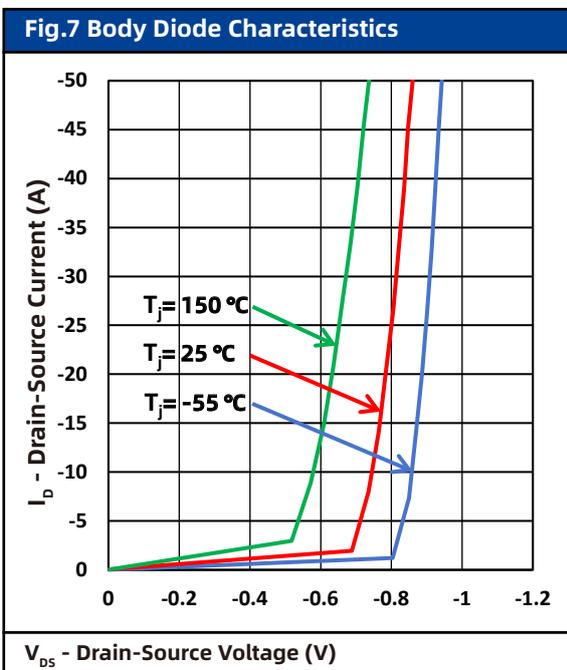
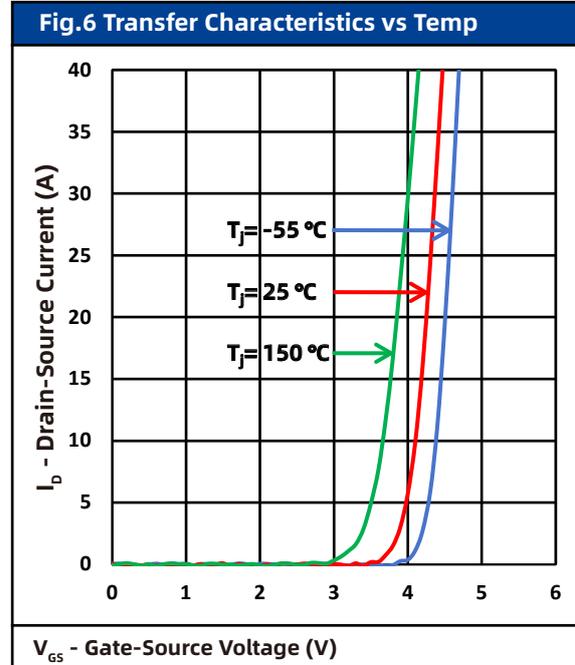
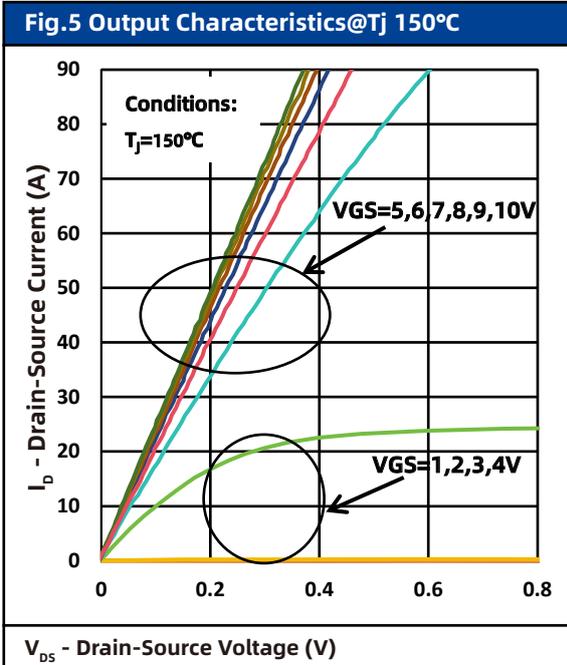


Fig.4 Transfer Characteristics@ $T_j 25^\circ\text{C}$



## 7. Typical Characteristics



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Fig.9 Gate Charge

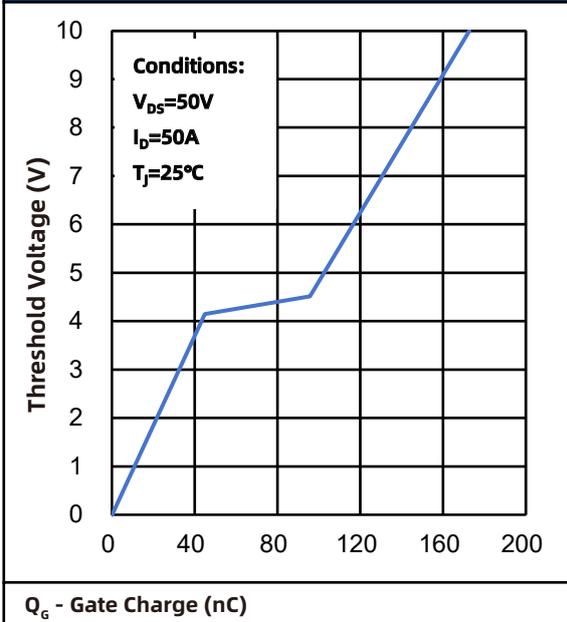


Fig.10 Capacitance

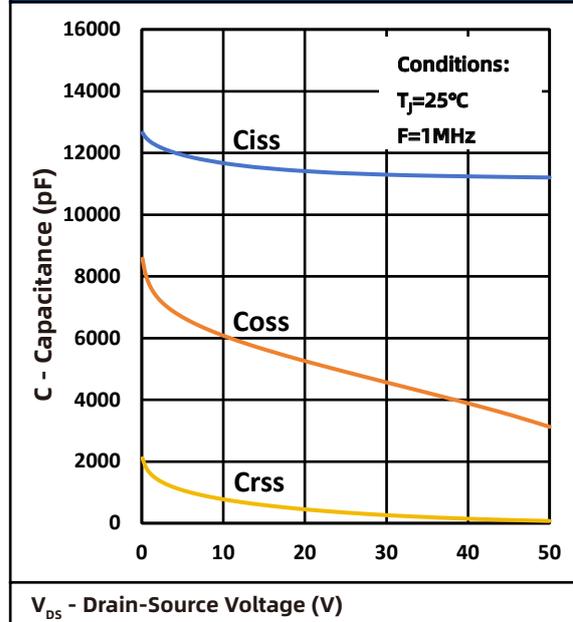


Fig.11 Normalized Threshold Voltage

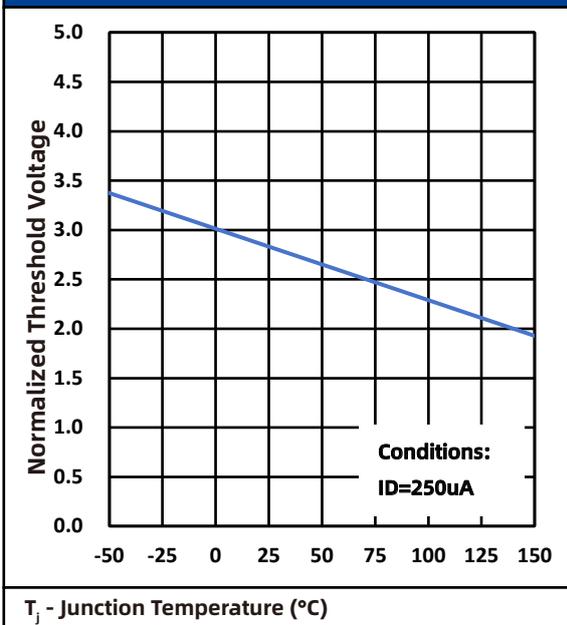
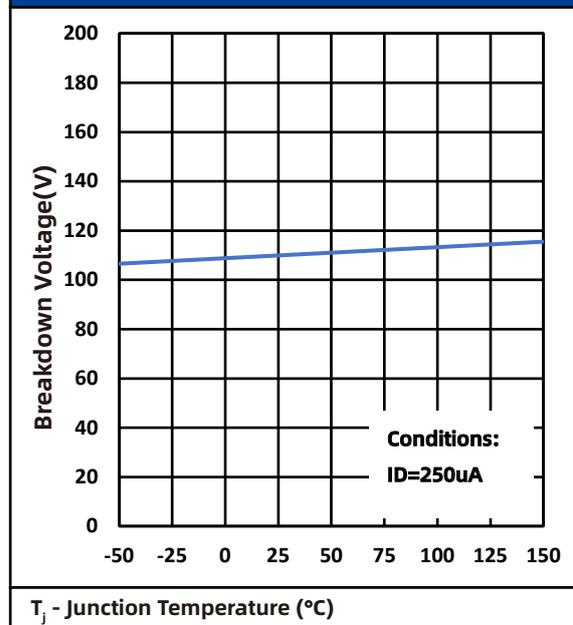
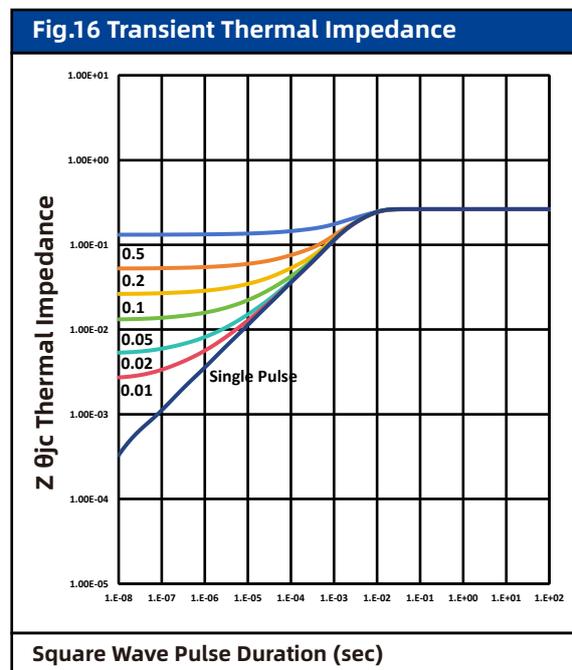
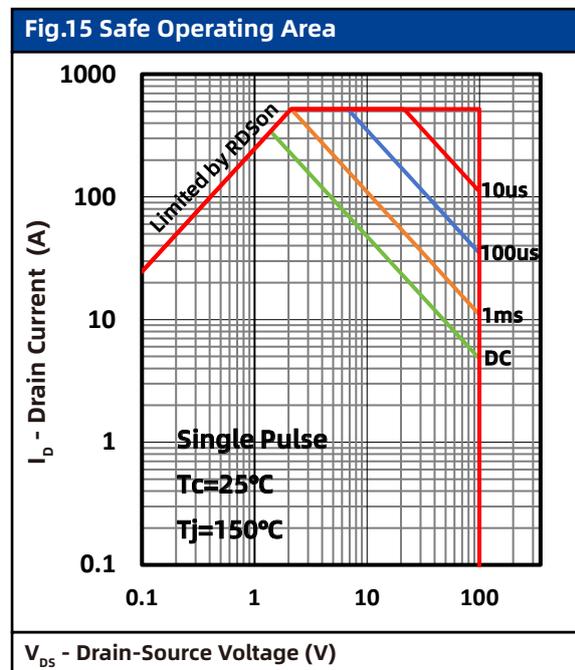
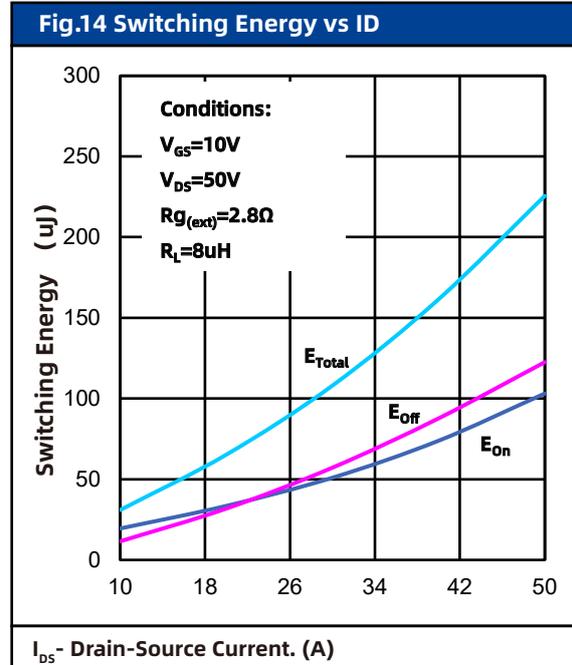
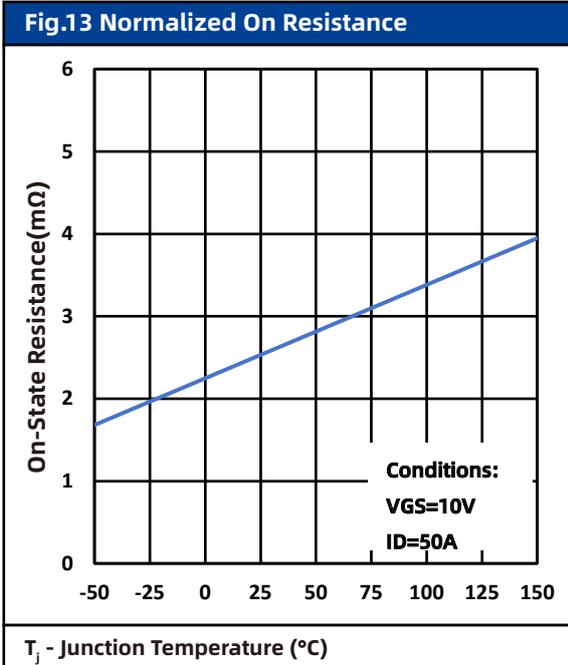


Fig.12 Normalized Breakdown Voltage



## 7. Typical Characteristics



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Fig.17 Gate Charge Test Circuit & Waveform

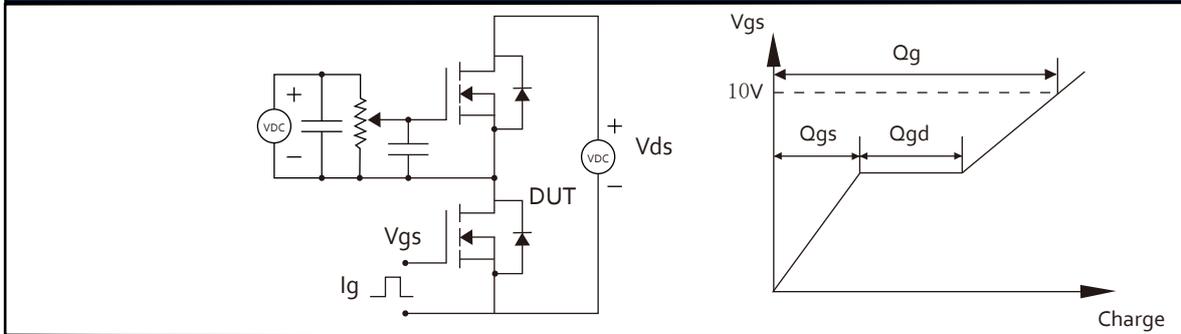


Fig.18 Resistive Switching Test Circuit & Waveforms

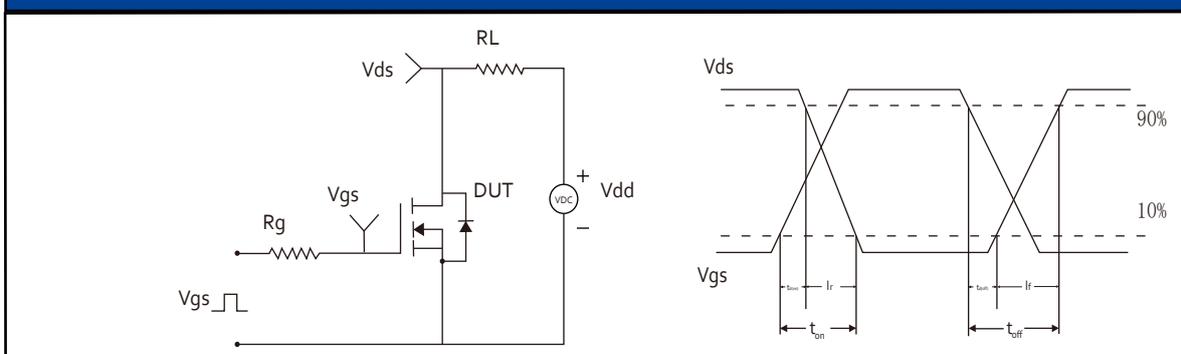


Fig.19 Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

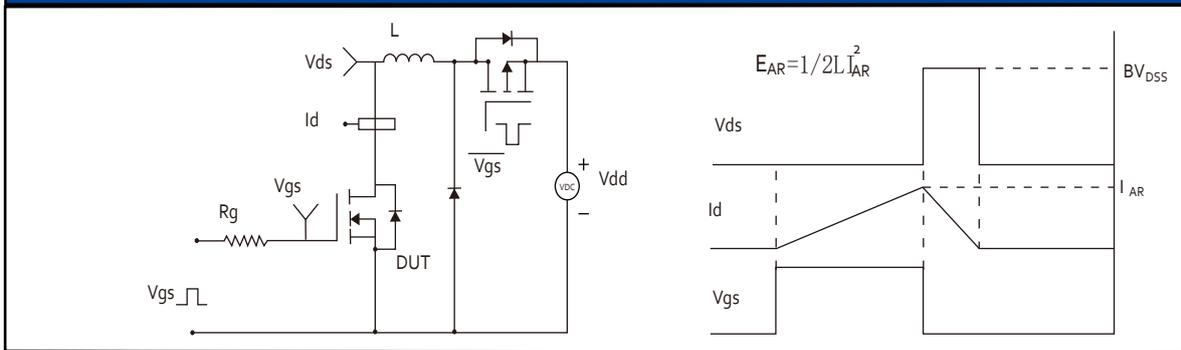
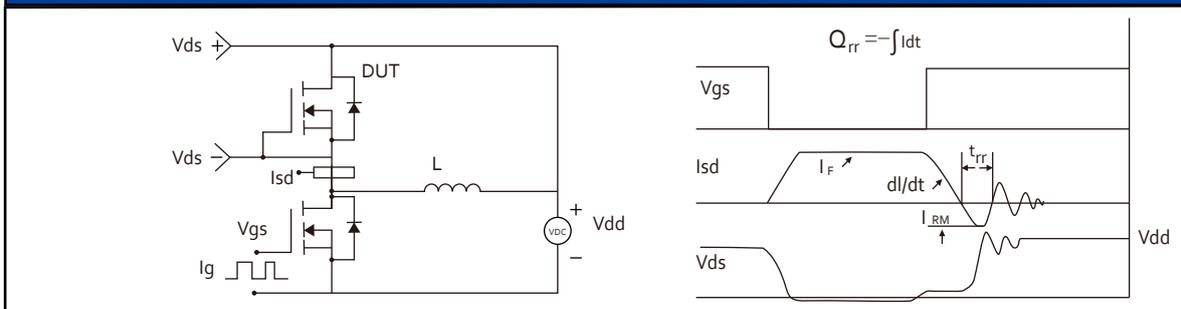
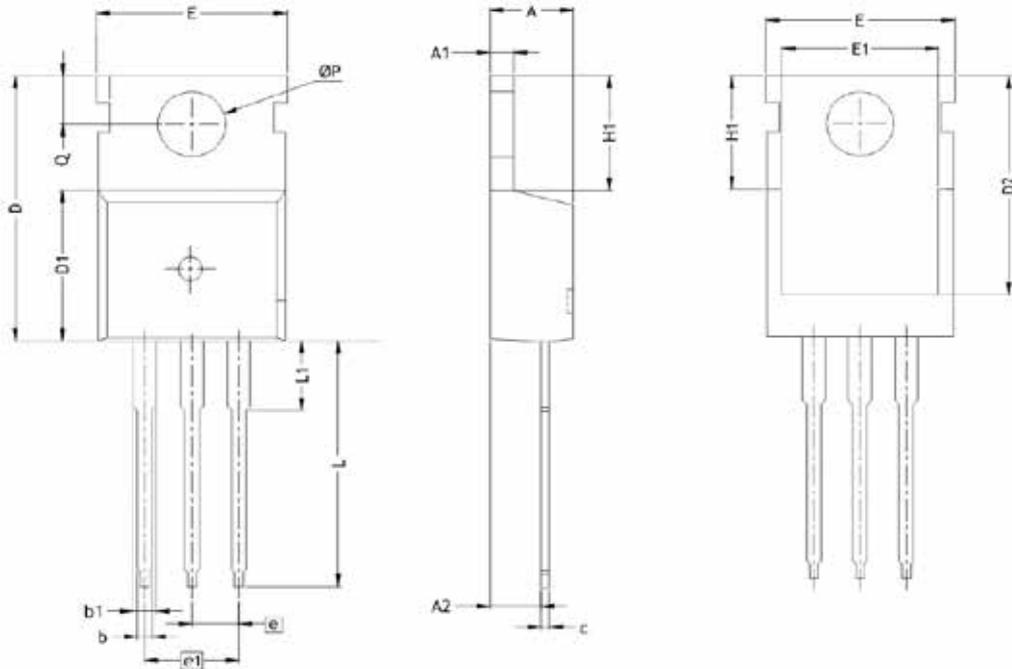


Fig.20 Diode Recovery Test Circuit & Waveforms



## 8. Package Dimensions

### TO-220C-3L Package



Symbol	Dimensions In Millimeters	
	MIN.	MAX.
A	4.25	4.65
A1	1.25	1.35
A2	2.35	2.55
b	0.7	0.9
b1	1.15	1.75
c	0.45	0.61
D	14.35	16.51
D1	8.58	9.50
D2	13.05	13.65
E	9.90	10.50
E1	7.85	8.89
e	2.54BSC	
e1	5.08BSC	
H1	6.30	6.65
L	12.85	13.50
L1	2.85	3.25
ΦP	3.53	4.09
Q	2.70	2.93

## 9. Record of Document amendment

产品名称：LN019N100C  
版权说明：镭诺电子（宁波）有限公司  
联系电话：4008887385

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版本：01  
修改记录：  
1.初版发行